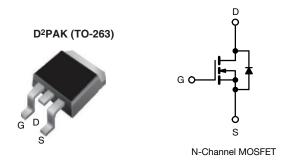
HALOGEN

FREE

www.vishay.com Vishay Siliconix

## **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	100				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V 0.54				
Q <sub>g</sub> max. (nC)	8.3				
Q <sub>gs</sub> (nC)	2.3				
Q <sub>gd</sub> (nC)	3.8				
Configuration	Single				



#### **FEATURES**

- Surface mount
- · Available in tape and reel
- Dynamic dV/dt rating
- · Repetitive avalanche rated
- 175 °C operating temperature
- · Fast switching
- · Ease of paralleling
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

#### **DESCRIPTION**

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance cost-effectiveness.

The D<sup>2</sup>PAK (TO-263) is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D2PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION						
Package	D <sup>2</sup> PAK (TO-263)	D <sup>2</sup> PAK (TO-263)	D <sup>2</sup> PAK (TO-263)			
Lead (Pb)-free and Halogen-free	SiHF510S-GE3	SiHF510STRL-GE3 <sup>a</sup>	SiHF510STRR-GE3 a			
Load (Dh) fron	IRF510SPbF	IRF510STRLPbF a	IRF510STRRPbF <sup>a</sup>			
Lead (Pb)-free	SiHF510S-E3	SiHF510STL-E3 a	SiHF510STR-E3 a			

#### Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (To	= 25 °C, un	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	100	V	
Gate-Source Voltage			V <sub>GS</sub>	± 20	v	
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$	1	5.6		
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	4.0	Α	
Pulsed Drain Current a			I <sub>DM</sub>	20		
Linear Derating Factor				0.29	W/°C	
Linear Derating Factor (PCB mount) e				0.025	VV/ C	
Single Pulse Avalanche Energy b			E <sub>AS</sub>	75	mJ	
Avalanche Current <sup>a</sup>			I <sub>AR</sub>	5.6	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	4.3	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			P <sub>D</sub>	43	w	
Maximum Power Dissipation (PCB mount) e T <sub>A</sub> = 25 °C				3.7	] vv	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering Recommendations (Peak temperature) d for 10 s			<u> </u>	300	7	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 4.8 \,\text{mH}$ ,  $R_g = 25 \,^{\circ}\text{C}$ ,  $I_{AS} = 5.6 \,\text{A}$  (see fig. 12). c.  $I_{SD} \leq 5.6 \,\text{A}$ ,  $I_{AS} = 5.6 \,\text{A}$ ,  $I_{AS} = 5.6 \,\text{A}$  (see fig. 12).
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).

Document Number: 91016



# Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62			
Maximum Junction-to-Ambient (PCB mount) <sup>a</sup>	R <sub>thJA</sub>	-	40	°C/W		
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	3.5			

#### Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						•	,
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub>	= 0, I <sub>D</sub> = 250 μA	100		-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.12	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 20 \text{ V}$	-		± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		: 100 V, V <sub>GS</sub> = 0 V	-	-	25	μA
			$V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ}\text{C}$	-	-	250	F
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 3.4 \text{ A}^{\text{ b}}$	-	-	0.54	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	50 V, I <sub>D</sub> = 3.4 A <sup>b</sup>	1.3	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	180	-	
Output Capacitance	Coss		$V_{DS} = 25 \text{ V},$	-	81	-	рF
Reverse Transfer Capacitance	$C_{rss}$	t = 1.	f = 1.0 MHz, see fig. 5		15	-	
Total Gate Charge	$Q_g$			-	-	8.3	nC
Gate-Source Charge	$Q_gs$	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_{D} = 5.6 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and fig. 13 b		-	2.3	
Gate-Drain Charge	$Q_{gd}$				-	3.8	
Turn-On Delay Time	t <sub>d(on)</sub>			-	6.9	-	
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, I_{D} = 5.6 \text{ A},$ $R_{g} = 24 \Omega, R_{D} = 8.4 \Omega, \text{ see fig. } 10^{\text{ b}}$		-	16	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	15	-	
Fall Time	t <sub>f</sub>			-	9.4	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	الم
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	5.6	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	20	A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	, I <sub>S</sub> = 5.6 A, V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	2.5	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = 5.6 \text{A},  \text{dI/dt} = 100 \text{A/µs}^{\text{b}}$		-	100	200	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.44	0.88	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	on is dor	ninated b	v L <sub>s</sub> and	L <sub>D</sub> )	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %.



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

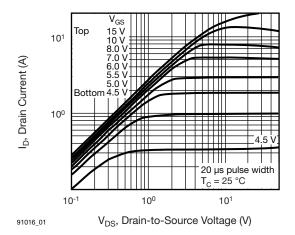


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

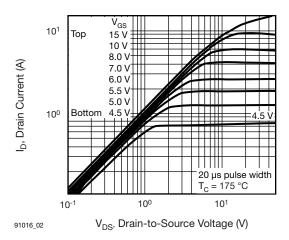


Fig. 2 - Typical Output Characteristics,  $T_C = 175$  °C

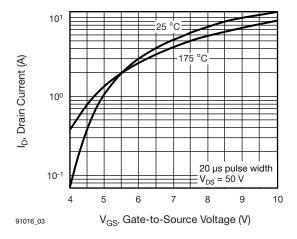


Fig. 3 - Typical Transfer Characteristics

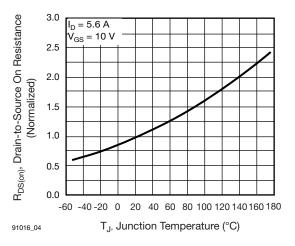


Fig. 4 - Normalized On-Resistance vs. Temperature

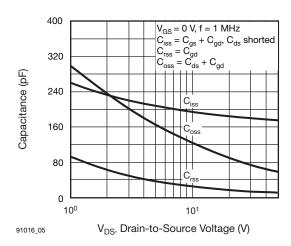


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

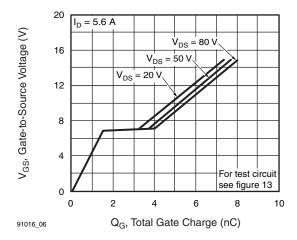


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



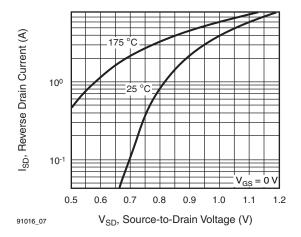


Fig. 7 - Typical Source-Drain Diode Forward Voltage

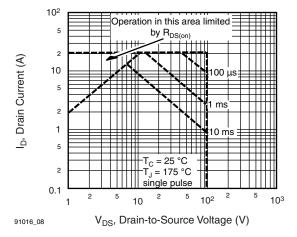


Fig. 8 - Maximum Safe Operating Area

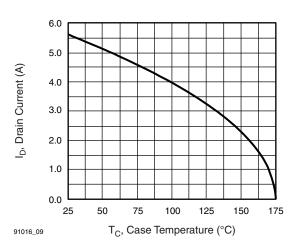


Fig. 9 - Maximum Drain Current vs. Case Temperature

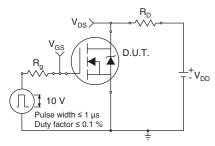


Fig. 10a - Switching Time Test Circuit

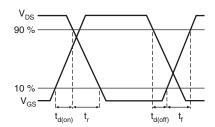


Fig. 10b - Switching Time Waveforms

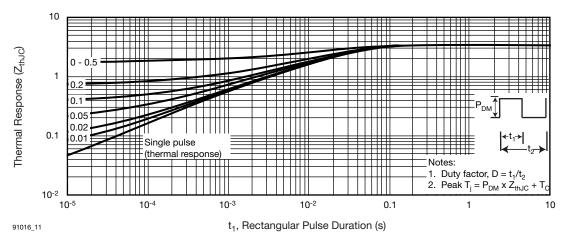


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



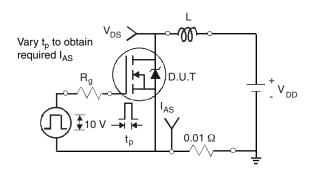


Fig. 12a - Unclamped Inductive Test Circuit

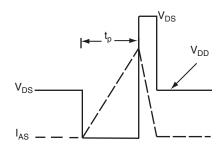


Fig. 12b - Unclamped Inductive Waveforms

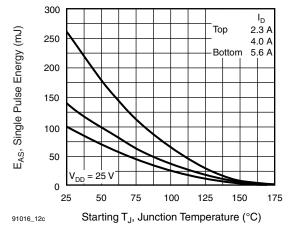


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

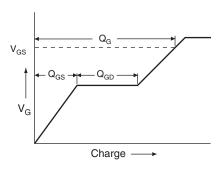


Fig. 13a - Basic Gate Charge Waveform

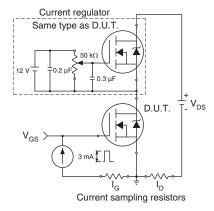
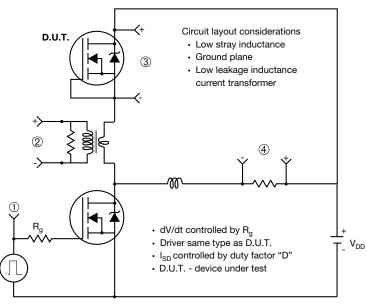


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



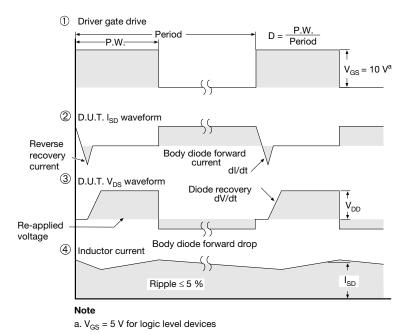


Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?91016">www.vishay.com/ppg?91016</a>.





### **TO-263AB (HIGH VOLTAGE)**







]	+		D1	4
	-E1-	<b>₩</b>	<u> </u>	7

	MILLIN	METERS	INC	HES
DIM.	MIN. MAX.		MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIN	METERS	INC	HES	
DIM.	MIN.	MIN. MAX.		MAX.	
D1	6.86	-	0.270	-	
E	9.65	10.67	0.380	0.420	
E1	6.22	-	0.245	i	
е	2.54	BSC	0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	ı	0.066	
L2	-	1.78	i	0.070	
L3	0.25	BSC	0.010	BSC	
L4	4.78	5.28	0.188	0.208	

### DWG: 5970 Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).

ECN: S-82110-Rev. A, 15-Sep-08

- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

Document Number: 91364 www.vishay.com Revision: 15-Sep-08



# **Legal Disclaimer Notice**

Vishay

# **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

# Vishay:

IRF510STRRPBF IRF510STRLPBF IRF510S IRF510STRL IRF510STRR IRF510SPBF